# LM2202

LM2202 230 MHz Video Amplifier System



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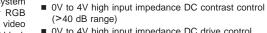
## **General Description**

The LM2202 is a very high frequency video amplifier system intended for use in high resolution monochrome or RGB color monitor applications. In addition to the wideband video amplifier the LM2202 contains a gated differential input black level clamp comparator for brightness control, a DC controlled attenuator for contrast control and a DC controlled attenuator for contrast control. The DC control for the contrast attenuator is pinned out separately to provide a more accurate control system for RGB color monitor applications. All DC controls offer a high input impedance and operate over a 0V to 4V range for easy interface to bus controlled alignment systems. The LM2202 operates from a nominal 12V supply but can be operated with supply voltages down to 8V for applications that require reduced IC package power dissipation characteristics.

## Features

Wideband video amplifier

 $(f_{-3dB} = 230 \text{ MHz at } V_O = 4 V_{PP})$ 



•  $t_r$ ,  $t_f = 1.5$  ns at  $V_O = 4 V_{PP}$ 

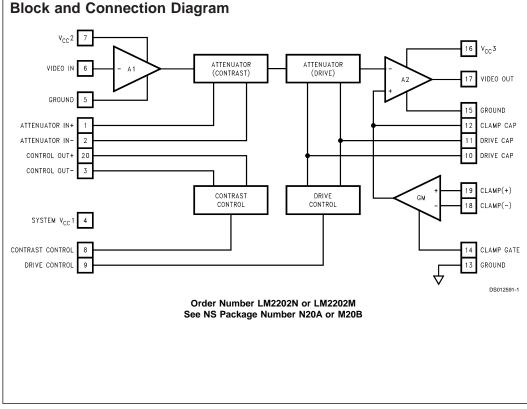
 0V to 4V high input impedance DC drive control (±3 dB range)

Externally gated comparator for brightness control

- Easy to parallel three LM2202s for optimum color tracking in RGB systems
- Output stage clamps to 0.65V and provides up to 9V output voltage swing
- Output stage directly drives most hybrid or discrete CRT amplifier stages
- Replacement for the LM1202

## Applications

- High resolution CRT monitors
- Video switches
- Video AGC amplifier
- Wideband amplifier with gain and DC offset control



## Absolute Maximum Ratings (Note 1)

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If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage V <sub>CC</sub> Pins 4, 7, 16 to	
Ground Pins 5, 13, 15	13.5V
Voltage at Any Input Pin (V <sub>IN</sub> )	$V_{CC} \geq V_{IN} \geq GND$
Video Output Current (I17)	28 mA
Package Power Dissipation at	
$T_A = 25^{\circ}C$	1.56W
(Above 25°C Derate Based θ <sub>JA</sub> and T <sub>J</sub>	)

Package Thermal Resistance ( $\theta_{JA}$ )	
N20A	68°C/W
M20B	90°C/W
Junction Temperature (T <sub>J</sub> )	150°C
Storage Temperature Range (T <sub>stg</sub> )	-65°C to +150°C
Lead Temperature N Package (Soldering, 10 sec.)	265°C
ESD Susceptibility Human Body Model: 100 pF Discharged through a 1.5k	
Resistor	1.5 kV

## **Operating Ratings** (Note 2)

Temperature Range	-20°C to +80°C
Supply Voltage (V <sub>CC</sub> )	$8V \le V_{CC} \le 13.2V$

## **DC Electrical Characteristics**

See Test Circuit (*Figure 1*),  $T_A = 25$ °C, V4 = V7 = V16 = 12V, S1 Open, V19 = 4V, V8 = 4V, V9 = 4V, V14 = 0V unless otherwise noted.

Symbol	Parameter	Conditions	Typical (Note 3)	Limit (Note 4)	Units
I <sub>S</sub> 4, 7, 16	Total Supply Current	$R_{LOAD} = \infty$ (Note 5)	48	60	mA (max)
V <sub>6</sub>	Video Input Bias Voltage		2.4	2	V (min)
V <sub>14L</sub>	Clamp Gate Low Input Voltage	Clamp Comparator On		0.8	V (max)
V <sub>14H</sub>	Clamp Gate High Input Voltage	Clamp Comparator Off		2	V (min)
I <sub>14L</sub>	Clamp Gate Low Input Current	V <sub>14</sub> = 0V	-0.5		μA
I <sub>14H</sub>	Clamp Gate High Input Current	V <sub>14</sub> = 12V	0.005		μA
I <sub>12+</sub>	Clamp Cap Charge Current	V <sub>12</sub> = 0V	800	500	μA (min)
I <sub>12-</sub>	Clamp Cap Discharge Current	V <sub>12</sub> = 5V	-800	-500	μA (min)
V <sub>17L</sub>	Video Output Low Voltage	V <sub>12</sub> = 0V	0.2	0.65	V (max)
V <sub>17H</sub>	Video Output High Voltage	V <sub>12</sub> = 6V	10	9	V (min)
Vos	Comparator Input Offset Voltage	V <sub>18</sub> - V <sub>19</sub>	15	±50	mV (max)

## **AC Electrical Characteristics**

See Test Circuit (*Figure 1*),  $T_A = 25$ °C, V4 = V7 = V16 = 12V, S1 Closed, V19 = 4V, V8 = 4V, V9 = 4V, V14 = 0V unless otherwise noted.

Symbol Parameter		Conditions	Typical (Note 3)	Limit (Note 4)	Units
R <sub>IN</sub>	Video Amplifier Input Resistance	f <sub>IN</sub> = 12 kHz	20		kΩ
A <sub>v</sub> max	Video Amplifier Gain	$V_8 = 4V, V_9 = 4V$	20	16	V/V (min)
$\Delta A_V 2V$	Attenuation at 2V	Ref: $A_V$ max, $V_8$ = 2V	-6		dB
$\Delta A_V 0.5V$	Attentuation at 0.5V	Ref: $A_V$ max, $V_8$ = 0.5V	-38	-23	dB (min)
$\Delta$ Drive	∆ Gain Range	$V_9 = 0V$ to 4V	6	5	dB (min)
THD	Video Amplifier Distortion	$V_{O} = 4 V_{PP}, f_{IN} = 12 \text{ kHz}$	0.5	1	% (max)
f_3 dB	Video Amplifier Bandwidth (Note 6)	$V_{O} = 4 V_{PP}$	230		MHz
t <sub>r</sub>	Output Rise Time (Note 6)	$V_{O} = 4 V_{PP}$	1.5	2	ns (max)
t <sub>f</sub>	Output Fall Time (Note 6)	$V_{O} = 4 V_{PP}$	1.5	2	ns (max)

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur.

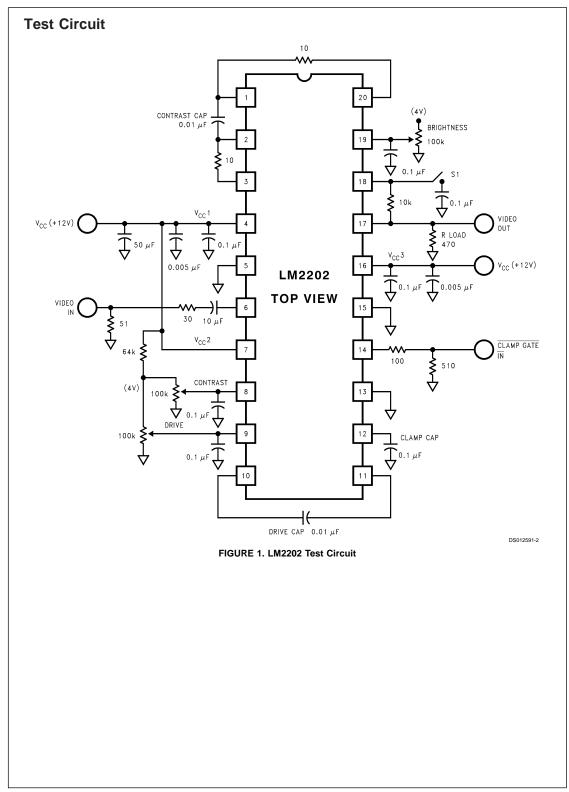
Note 2: Operating Ratings indicate conditions for which the device is functional but do not guarantee specific performance limits. For guaranteed specifications and test conditions see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

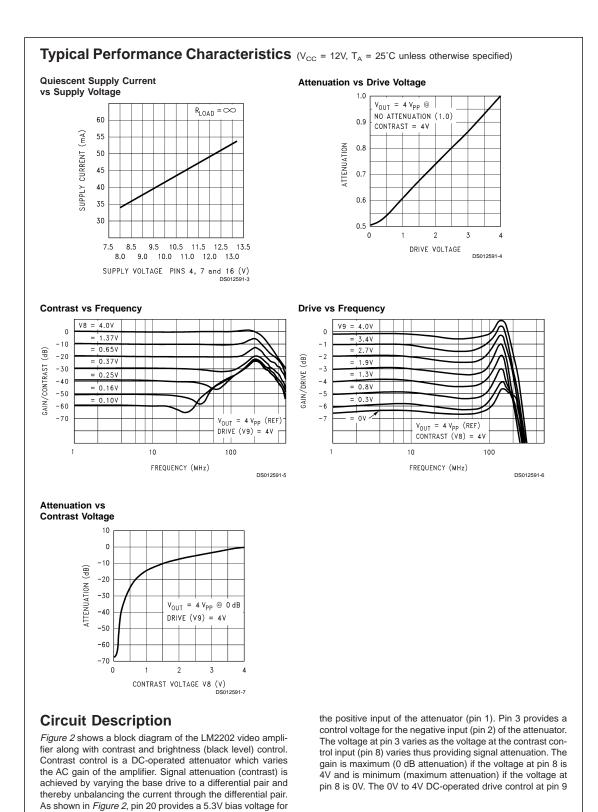
Note 3: Typical specifications are specified at +25°C and represent the most likely parametric norm.

Note 4: Tested limits are guaranteed to National's AOQL (Average Outgoing Quality Level).

Note 5: The supply current specified is the quiescent current for  $V_{CC1}$ ,  $V_{CC2}$  and  $V_{CC3}$  with  $R_{Load} = \infty$ , see *Figure 1's* test circuit. The total supply current also depends on the output load,  $R_{Load}$ . The increase in device power dissipation due to  $R_{Load}$  must be taken into account when operating the device at the maximum ambient temperature.

Note 6: When measuring video amplifier bandwidth or pulse rise and fall times, a double sided full ground plane printed circuit board is recommended. The measured rise and fall times are effective rise and fall times, taking into account the rise and fall times of the generator and the oscilloscope.





## Circuit Description (Continued)

provides a 6 dB gain adjustment range. This feature is necessary for RGB applications where independent gain adjustment of each channel is required.

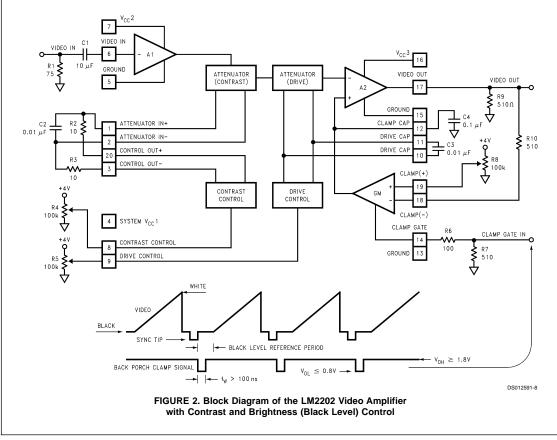
The brightness or black level clamping requires a "sample and hold" circuit which holds the DC bias of the video amplifier constant during the black level reference portion of the video waveform. Black level clamping, often referred to as DC restoration, is accomplished by applying a back porch clamp signal to the clamp gate input pin (pin 14). The clamp comparator is enabled when the clamp signal goes low during the black level reference period (see Figure 2). When the clamp comparator is enabled, the clamp capacitor connected to pin 12 is either charged or discharged until the voltage at the minus input of the comparator matches the voltage set at the plus input of the comparator. During the video portion of the signal, the clamp comparator is disabled and the clamp capacitor holds the proper DC bias. In a DC coupled cathode drive application, picture brightness function can be achieved by varying the voltage at the comparator's plus input. Note that the back porch clamp pulse width (tw in Figure 2) must be greater than 100 ns for proper operation.

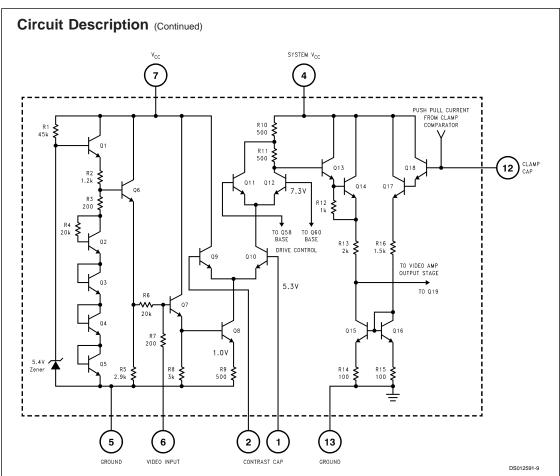
#### VIDEO AMPLIFIER SECTION (Input Stage)

A simplified schematic of LM2202's video amplifier input stage is shown in *Figure 3*. The 5.4V zener diode, Q1, Q6 and R2 bias the base of Q7 at 2.6V. The AC coupled video

signal applied to pin 6 is referenced to the 2.6V bias voltage. Transistor Q7 buffers the video signal,  $\mathrm{V}_{\mathrm{IN}}$  and Q8 converts the voltage to current. The AC collector current through Q8 is  $I_{C8} = V_{IN}/R9$ . Under maximum gain condition, transistors Q9 and Q11 are off and all of  ${\rm I}_{\rm C8}$  flows through the load resistors R10 and R11. The maximum signal gain at the base of Q13 is,  $A_{V1} = -(R10 + R11)/R9 = -2$ . Signal attenuation is achieved by varying the base drive to the differential pairs Q9, Q10 and Q11, Q12 thereby unbalancing the collector currents through the transistor pairs. Base of Q10 is biased at 5.3V by externally connecting pin 1 to pin 20 through a 100 $\Omega$  resistor. Pin 2 is connected to pin 3 through a 100 $\Omega$  resistor. Adjusting the contrast voltage at pin 8 produces a control voltage at pin 3 which drives the base of Q9. By varving the voltage at the base of Q9, Q8's collector current ( $I_{C8}$ ) is diverted away from the load resistors R10 and R11, thereby providing signal attenuation. Maximum attenuation is achieved when all of  $I_{\rm C8}$  flows through Q9 and no current flows through the load resistors.

The differential pair Q11 and Q12 provide drive control. Q12's base is internally biased at 7.3V. Adjusting the voltage at the drive control input (pin 9) produces a control voltage at the base of Q11. With Q9 off and Q12 off, all of I<sub>C8</sub> flows through R10, thus providing a gain of A<sub>V1</sub> = -(R10/R9) x V<sub>IN</sub> = -1. Drive control thus provides a 6 dB attenuation range.





#### FIGURE 3. Simplified Schematic of the LM2202 Video Amplifier Input Stage

#### VIDEO AMPLIFIER SECTION (Output Stage)

A simplified schematic of LM2202's video amplifier output stage is shown in *Figure 4*. The output stage is the second gain stage. Ideally the gain of the second gain stage would be  $A_{V2} = -R21/R18 = -16$ . Because of the output stage's low open loop gain, the gain is approximately  $A_{V2} = -10$ . Thus the maximum gain of the video amplifier is  $A_V = A_{V1} \times A_{V2} = 20$ . Transistors Q23 and Q24 provide a push-pull drive to the load. The output voltage can swing from 0.2V to 10V.

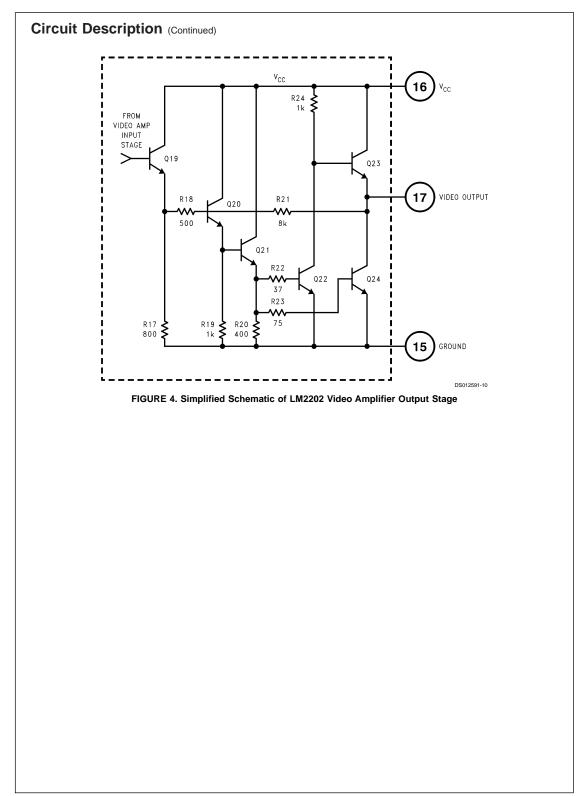
#### CONTRAST CONTROL SECTION

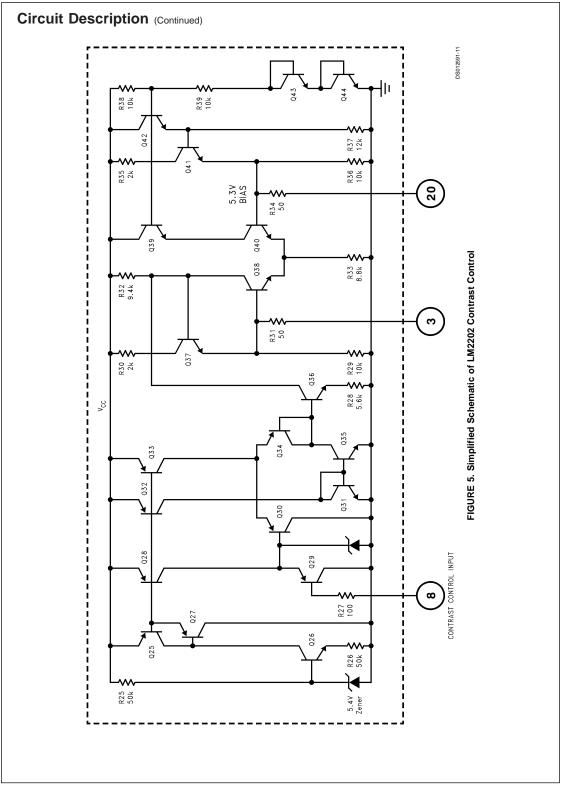
A simplified schematic of LM2202's contrast control section is shown in *Figure 5*. A 0V to 4V DC voltage is applied at the contrast input (pin 8). Transistors Q29, Q30 and Q34 buffer and level shift the contrast voltage to the base of Q36. The voltage at the emitter of Q36 equals the contrast voltage (V<sub>cont</sub>) and the current through Q36's collector is given by  $I_{\rm C36}=V_{\rm cont}/R28.$ 

Transistor Q36's collector current is used to unbalance the current through the differential pair comprised of Q38 and Q40. Q40's base is internally biased at 5.3V and made avail-

able at pin 20. Pin 20 is externally connected to pin 1 through a 100 $\Omega$  resistor (see *Figure 2* and *Figure 3*). The base of Q38 (pin 3) is externally connected to pin 2 through a 100 $\Omega$  resistor (see *Figure 2* and *Figure 3*). With V<sub>cont</sub> = 2V, the differential pair (Q38, Q40) is balanced and the voltage at pins 1 and 2 is 5.3V. Under this condition, Q8's collector current is equally split between Q9 and Q10 (see *Figure 3*) and the amplifier's gain is half the maximum gain. If contrast voltage at pin 8 is greater than 2V then Q36's collector current increases, thus pulling Q38's collector node lower and consequently moving Q38's base below 5.3V. With pin 2 at a lower voltage than pin 1, current through Q10 (see *Figure 3*) increases and the amplifier's gain is maximum.

If the contrast voltage at pin 8 is less than 2V then Q36's collector current decreases and Q38's base is pulled above 5.3V. With pin 2 voltage greater than pin 1 voltage, less current flows through Q10 (see *Figure 3*), consequently the amplifier's gain decreases. With  $V_{cont} = 0V$ , the amplifier's gain is minimum (i.e., maximum attenuation).





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## Circuit Description (Continued)

#### DRIVE CONTROL SECTION

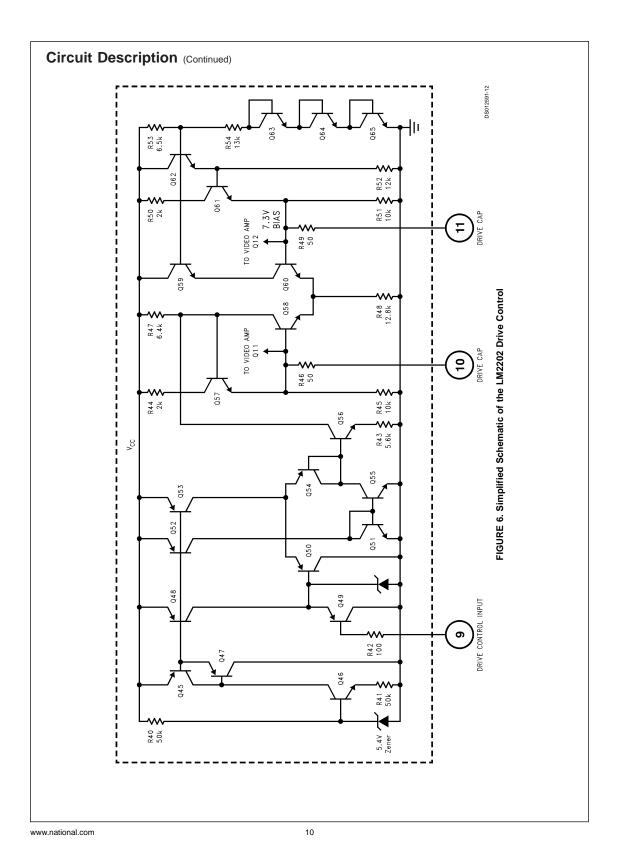
A simplified schematic of the LM2202's drive control section is shown in *Figure 6*. A 0V to 4V DC voltage is applied at the drive control input (pin 9). Transistors Q49, Q50 and Q54 buffer and level shift the contrast voltage to the base of Q56. The voltage at the emitter of Q56 equals the drive voltage, V<sub>drive</sub> and the current through Q56's collector is given by I<sub>C56</sub> = V<sub>drive</sub>/R43.

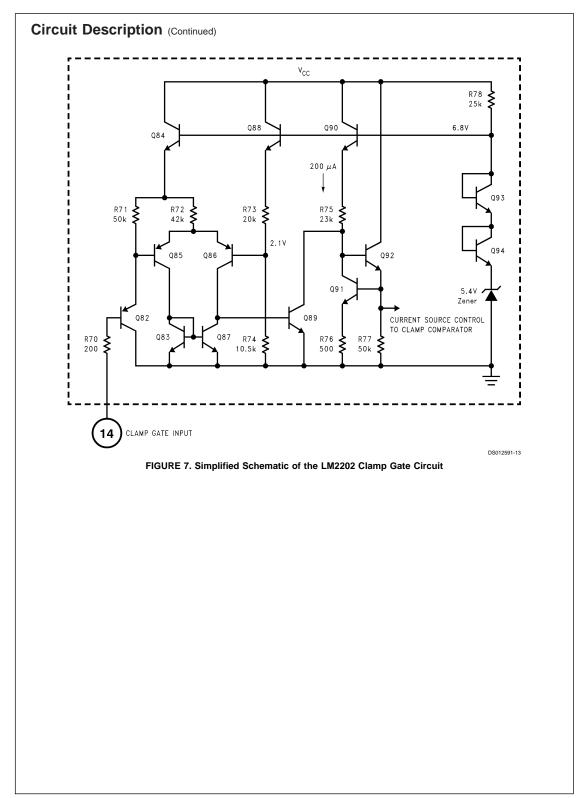
Transistor Q56's collector current is used to unbalance the current through the differential pair comprised of Q58 and Q60. Q60's base is internally biased at 7.3V and connected to the base of Q12 (see *Figure 3*). Q58's base is internally connected to the base of Q11 (see *Figure 3*). With  $V_{cont} = 2V$ , the differential pair (Q58, Q60) is balanced and the voltage at the bases of Q11 and Q12 is 7.3V. Under this condition, Q10's collector current is equally split between Q11 and Q12 (see *Figure 3*). If the drive voltage at pin 9 is greater than 2V then Q56's collector current increases, thus pulling Q58's collector node lower and consequently moving Q58's base below 7.3V. With base of Q11 below 7.3V, current through Q12 (see *Figure 3*) increases and the amplifier's gain increases. With  $V_{drive} = 4V$ , the amplifier's gain is maximum under maximum contrast condition (i.e.,  $V_{cont} = 4V$ ).

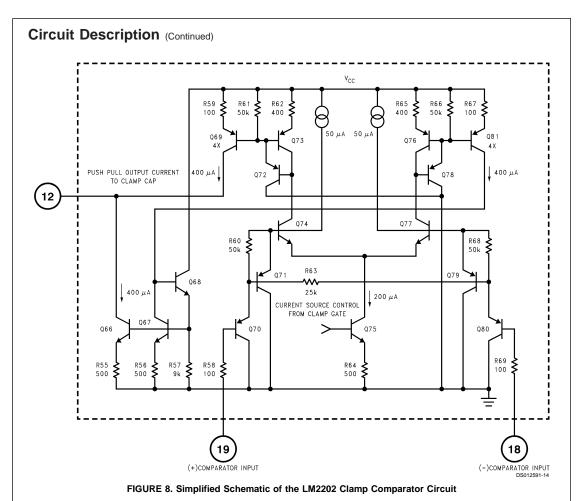
If the drive voltage at pin 8 is less than 2V then Q56's collector current decreases and Q58's base is pulled above 7.3V. With base of Q11 greater than 7.3V, less current flows through Q12 (see *Figure 3*), consequently the amplifier's gain decreases. With  $V_{drive}$  = 0V, the amplifier's gain is 6 dB less than the maximum gain.

#### CLAMP GATE AND CLAMP COMPARATOR SECTION

Figure 7 and Figure 8 show simplified schematics of the clamp gate and clamp comparator circuits. The clamp gate circuit (Figure 7) consists of a PNP input buffer transistor (Q82), a PNP emitter coupled pair (Q85 and Q86) referenced on one side to 2.1V and an output switch transistor Q89. When the clamp gate input at pin 14 is high (> 1.5V) the Q89 switch is on and shunts the 200 µA current from current source Q90 to ground. When pin 14 is low (< 1.3V) the Q89 switch is off and the 200 µA current is mirrored by the current mirror comprised of Q91 and Q75 (see Figure 8). Consequently the clamp comparator comprised of the differential pair Q74 and Q77 is enabled. The input of the clamp comparator is similar to the clamp gate except that an NPN emitter coupled pair is used to control the current that will charge or discharge the clamp capacitor externally connected from pin 12 to ground. PNP transistors are used at the inputs because they offer a number of advantages over NPNs. PNPs will operate with base voltages at or near ground and will usually have a greater emitter base breakdown voltage (BVebo). Because the differential input voltage to the clamp comparator during the video scan period could be greater than the BVebo of NPN transistors, a resistor (R63) with a value one half that of R60 or R68 is connected between the bases of Q71 and Q79. The clamp comparator's common mode range is from ground to approximately 9V and the maximum differential input voltage is V<sub>CC</sub>.









#### SINGLE VIDEO CHANNEL

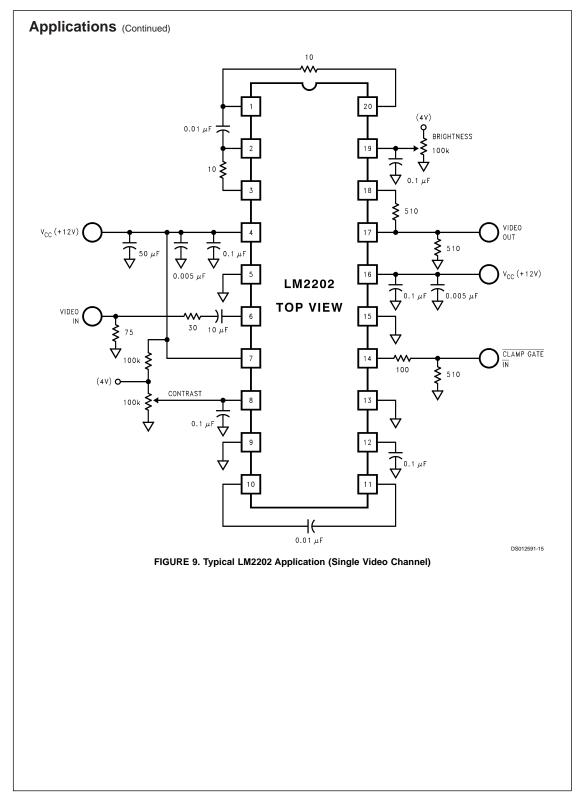
A typical application for a single video channel is shown in *Figure 9*. The video signal is AC coupled to pin 6. The LM2202 internally biases the video signal to 2.6 V<sub>DC</sub>. Contrast control is achieved by applying a 0V to 4V DC voltage at pin 8. The amplifier's gain is minimum (i.e., maximum signal attenuation) if pin 8 is at 0V and is maximum if pin 8 is at 4V. With pin 9 (drive control) at 0V, the amplifier has a maximum gain of 10.

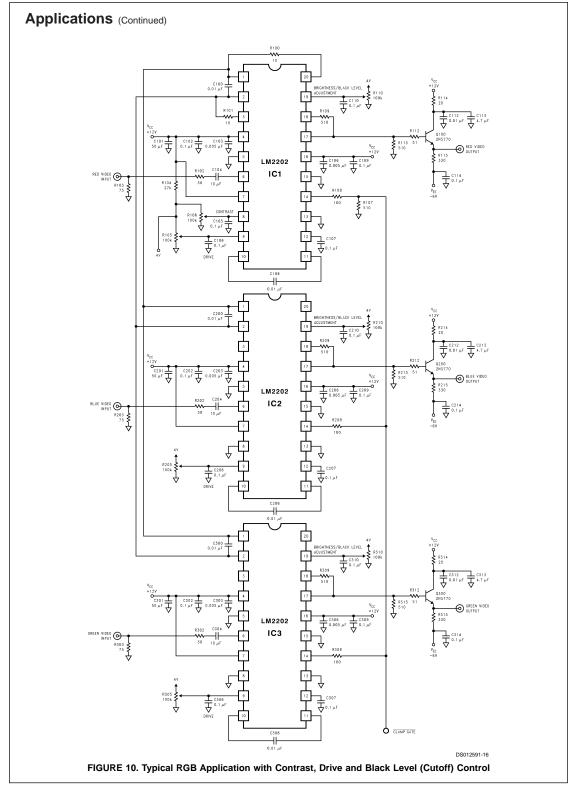
For DC restoration, a clamp signal must be applied to the clamp gate input (pin 14). The clamp signal should be logic low (less than 0.8V) only during the back porch (black level reference period) interval (see *Figure 2*). The clamp gate input is TTL compatible. Brightness control is provided by applying a 0V to 4V DC voltage at pin 19. For example, if pin 19 is biased at 1V then the video signal's black level will be clamped at 1V. A 510 $\Omega$  load resistor is connected from the video output pin (pin 17) to ground. This resistor biases the output stage of the amplifier. For power dissipation considerations, the load resistor should not be much less than 510 $\Omega$ .

#### **RGB VIDEO PREAMPLIFIER**

Figure 10 shows an RGB video preamplifier circuit using three LM2202s. Note that pins 1 and 2 of IC1 are connected to pins 1 and 2 of IC2 and IC3 respectively. This allows IC1 to provide a master contrast control and optimum contrast tracking. Adjusting the contrast voltage at pin 8 of IC1 will vary the gain of all three video channels. Drive control input (pin 9) of each LM2202 allows individual gain adjustment for achieving white balance.

The black level of each video channel can be individually adjusted to the desired voltage by adjusting the voltage at pin 19. In a DC-coupled cathode drive application, adjusting the voltage at pin 19 of each IC will provide cutoff adjustment. In an AC-coupled cathode drive application, the video signal is AC coupled and DC restored at the cathode. In such an application, the video signal's black level may be clamped to the desired level by simply biasing pin 19 to the black level voltage by using a voltage divider at pin 19.





## **Power Down Characteristics**

The LM2202 includes a built-in power down spot killer to prevent a flash on the screen upon power down. The LM2202's output voltage decreases as the device is being powered down, thus preventing a flash on the screen. In some preamplifiers, the video output signal may go high as the device is being powered down. This may cause a whiter-than-white level at the output of the CRT driver, thus causing a flash on the screen.

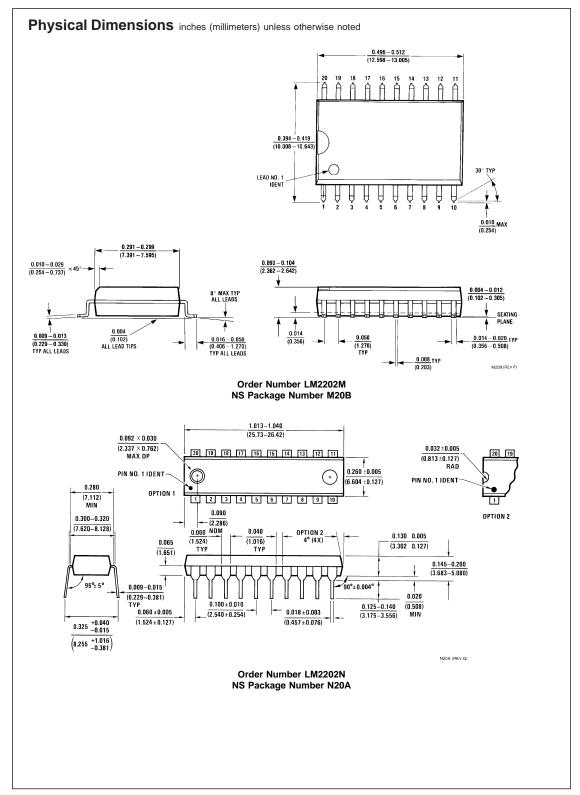
## PC Board Layout Considerations

For optimum performance and stable operation, a double-sided printed circuit board with adequate ground

plane and power supply decoupling as close to the V<sub>CC</sub> pins as possible is recommended. For suggestions on optimum PC board layout, please see the reference section below.

### Reference

Ott, Henry W, Noise Reduction Techniques in Electronic Systems , John Wiley & Sons, New York, 1976.



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Notes

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